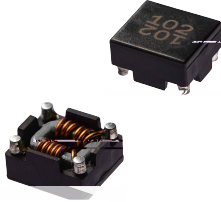


BCMA Series

Common Mode Filters For Automotive Signal Line
Size 1009



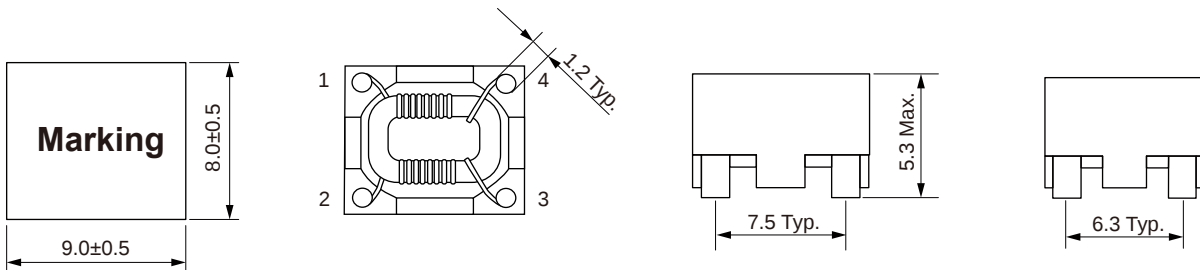
FEATURES

- High common mode impedance at high frequency cause excellent noise suppression performance
-
- currents (up to 5 A)
-
-

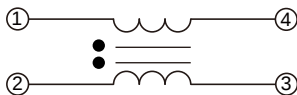
APPLICATION

- Measures against common mode noise in power lines
-
-
- Audio subsystem
- Digital instrument cluster
-

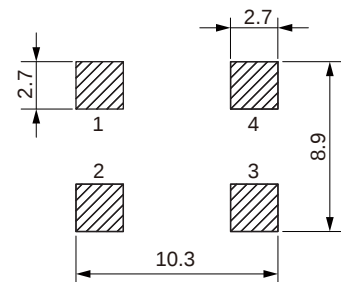
Dimensions: [mm]



Schematic:



Land Pattern: [mm]



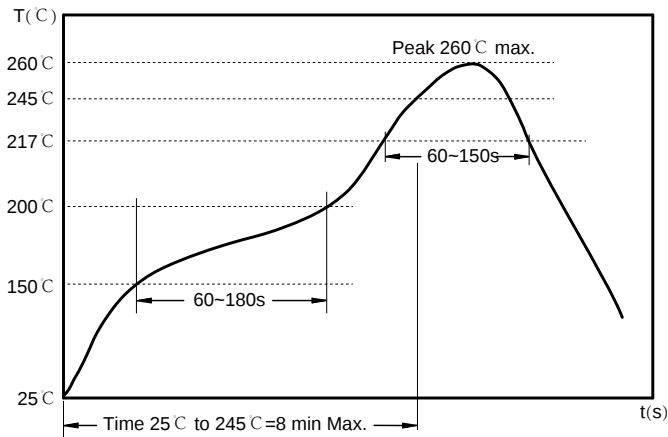
Electrical Properties:

[illegible]

Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$



Soldering Reflow:



Preheat condition: 150 ~ 200°C / 60~180 sec.

Allowed time above 217°C: 60~150 sec.

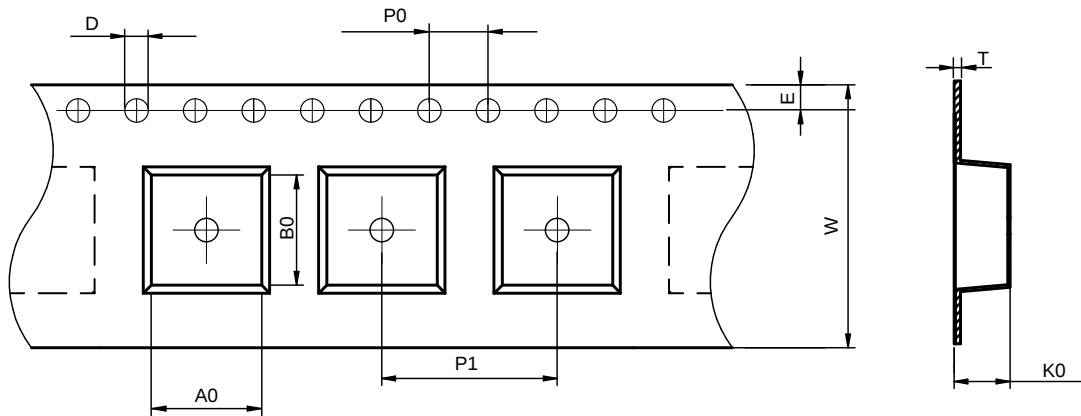
Max temperature: 260°C.

Max time at max temperature: 10 sec.

Allowed Reflow time: 3x max.

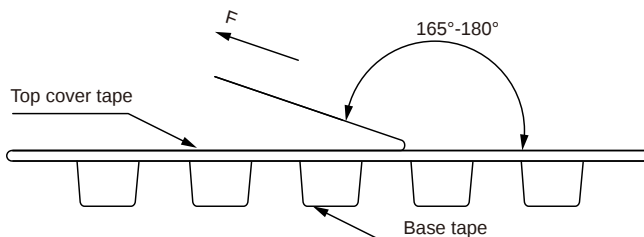
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
BCMA1009	8.6 ± 0.1	10.5 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	12.0 ± 0.1	24.0 ± 0.3	5.4 ± 0.1	1.75 ± 0.1	0.40 ± 0.05

Peel force of top cover tape:

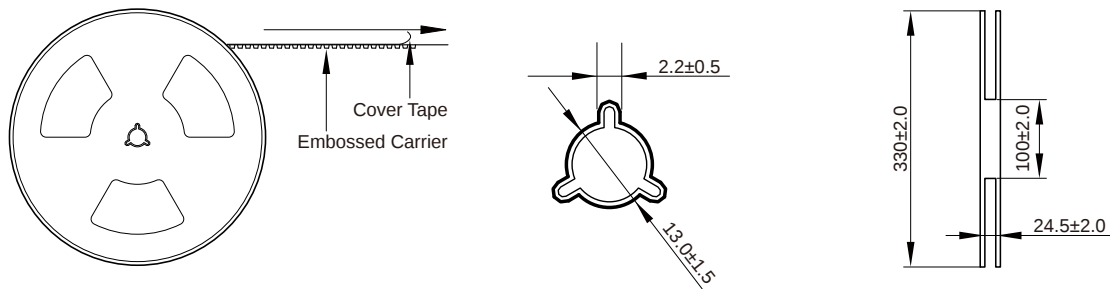


The peel force of top cover tape shall be between 0.20 to 1.17 N

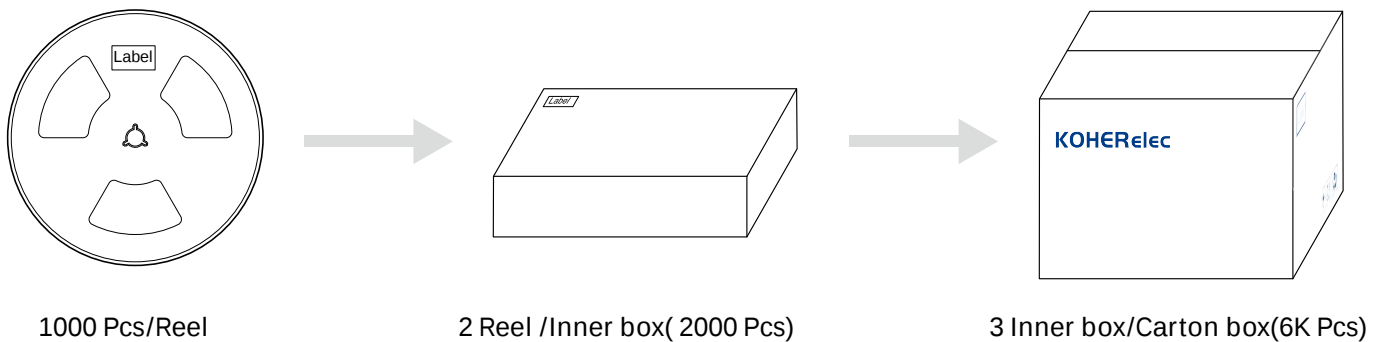
Product Marking:

Marking	Printing Inductance)
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Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C , humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C .
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.